

Max Memory Bandwidth	307.2 GB/s
Physical Address Extensions	46-bit
# of DIMMs	6
ECC Memory Supported ‡	Yes

Graphics Specifications		
Integrated Graphics ‡	Yes	
Graphics Output	D-sub	
Intel® Clear Video Technology	No	
Discrete Graphics	Supported	

Expansion Options	
PCI Support	yes
PCI Express Revision	3
PCIe x4 Gen 3	1
PCle x8 Gen 3	1
PCle x16 Gen 3	1
PCle x4 Gen 2.x	1
PCle x1 Gen 1.x	0
PCle x4 Gen 1.x	0
PCIe x8 Gen 1.x	0
PCle x16 Gen 1.x	0
IO Expansion x8 Gen 2.x	0

I/O Specifications	
USB 2.0 Configuration (Back + Internal)	6
RAID Configuration	SW Raid 0/1/10/5 (LSI + RSTE)
# of Serial Ports	2
# of LAN Ports	2
Integrated LAN	2x 1GbE
Embedded USB (eUSB) Solid State Drive Option	Yes
Integrated SAS Ports	8
Integrated InfiniBand*	No

Package Specifications	
Max CPU Configuration	1
Low Halogen Options Available	See MDDS

Advanced Technologies	
Intel® Virtualization Technology for Directed I/O (VT-d) ‡	Yes

AES New Instructions	Yes
Intel® vPro Technology ‡	No
Intel® ME Firmware Version	No
Intel® Remote Wake Technology	No
Intel® Remote PC Assist Technology	No
Intel® Remote Management Module Support	Yes
Intel® Node Manager	Yes
Intel® CIRA Technology	No
Intel® Anti-Theft Technology	No
TPM	Yes
TPM Version	1.2
Intel® Quick Resume Technology	No
Intel® Quiet System Technology	No
Intel® HD Audio Technology	No
Intel® AC97 Technology	No
Intel® Matrix Storage Technology	Yes
Intel® Fast Memory Access	Yes
Intel® Flex Memory Access	Yes
Intel® I/O Acceleration Technology	Yes
Intel® Advanced Management Technology	Yes
Intel® Server Customization Technology	No
Intel® Build Assurance Technology	No
Intel® Efficient Power Technology	No
Intel® Quiet Thermal Technology	Yes

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"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

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‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M.

Please contact OEM for the BIOS that includes the latest Processor configuration update.